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NOTE: The following appendix did not appear in the Code of Federal Regulations

APPENDIX B

FORM PTO-1595

1-31-92

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1. Name of conveying party(ies):
Hardayal Singh Gill

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Name: *INTERNATIONAL BUSINESS
MACHINES CORPORATION*
Internal Address: Armonk, New York 10504

Street Address: SAME AS ABOVE

Additional name(s) & address(es) attached?
___ yes X no

Additional name(s) of conveying party(ies) attached? ___ yes X no

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X Assignment ___ Merger
___ Security Agreement ___ Change of Name
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Execution Date: 03/19/2001

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: 03/19/2001

A. Patent Application No.(s)

B. Patent No.(s)

09813609

Additional numbers attached? ___ Yes X No

5. Name and address of party to whom correspondence concerning documents should be mailed:

Name: Ron Feece
Address: INTERNATIONAL BUSINESS MACHINES CORPORATION
5600 Cottle Road, L2PA/014
San Jose, California 95193

6. Total number of applications and patents involved: 1

7. Total Fee (37 CFR 3.41): \$ 40.00
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RON FEECE

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[Signature]
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**PATENT
REEL: 011665 FRAME: 0218**

11033 U.S. PTO
09/813609
03/20/01

ASSIGNMENT

Whereas, I

INVENTOR
AND CITY

(1) **Hardayal Singh Gill**
City of **Palo Alto,**
County of **Santa Clara**
State of **California,**

have invented certain improvements in

TITLE

DUAL SPIN VALVE SENSOR WITHOUT AFM PINNING

DATE THAT
INVENTOR
SIGNED THE
DECLARATION

and executed a Declaration and Power of Attorney for a United States patent application therefor on

(1) 3/19, 2001

Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to IBM, its successors and assigns; and I hereby agree that IBM may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

CITY
DATE

Signed
(1) at San Jose
on 3/19, 2001,

Hardayal Singh Gill SIGNATURE
INVENTOR